

General Description

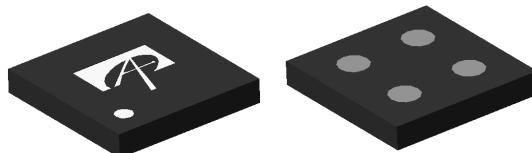
The AOC2403 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.5V while retaining a 8V $V_{GS(MAX)}$ rating.

Product Summary

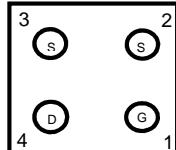
V_{DS}	-20V
I_D (at $V_{GS}=-4.5V$)	-1.8A
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	< 95mΩ
$R_{DS(ON)}$ (at $V_{GS}=-2.5V$)	< 115mΩ
$R_{DS(ON)}$ (at $V_{GS}=-1.8V$)	< 150mΩ
$R_{DS(ON)}$ (at $V_{GS}=-1.5V$)	< 200mΩ



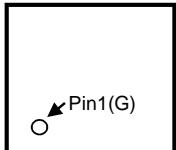
AlphaDFN 0.97x0.97_4



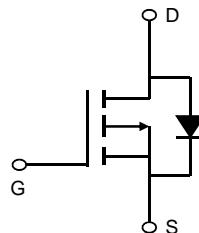
Bottom View



Top View



Equivalent Circuit



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 8	V
Source Current (DC) ^{Note1}	I_D $T_A=25^\circ\text{C}$	-1.8	A
Source Current (Pulse) ^{Note2}	I_{DM}	-20	
Power Dissipation ^{Note1}	P_D $T_A=25^\circ\text{C}$	0.45	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

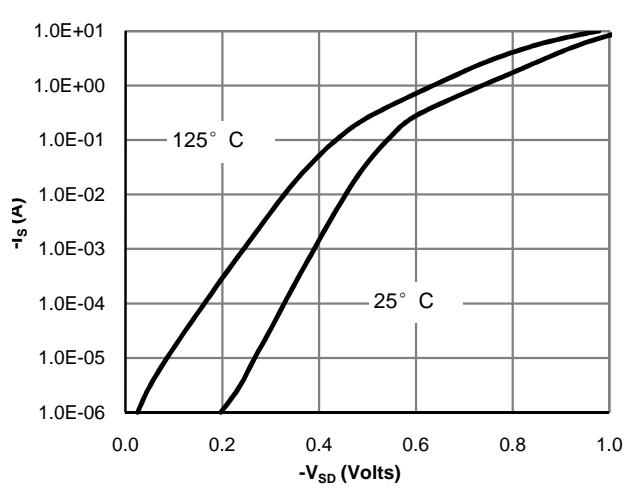
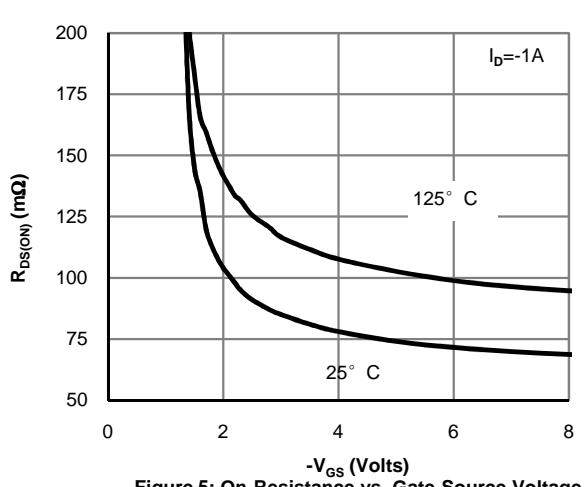
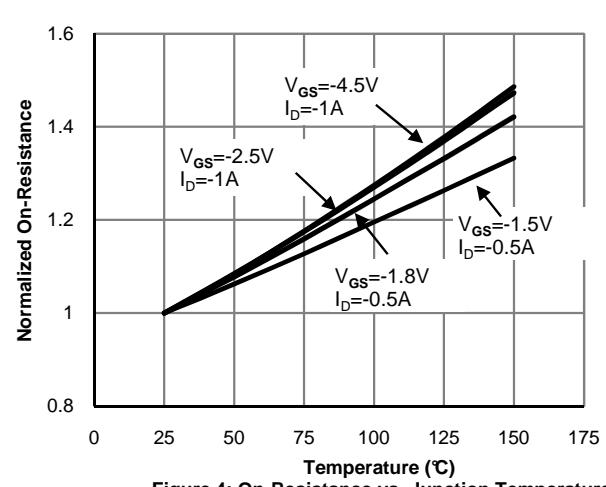
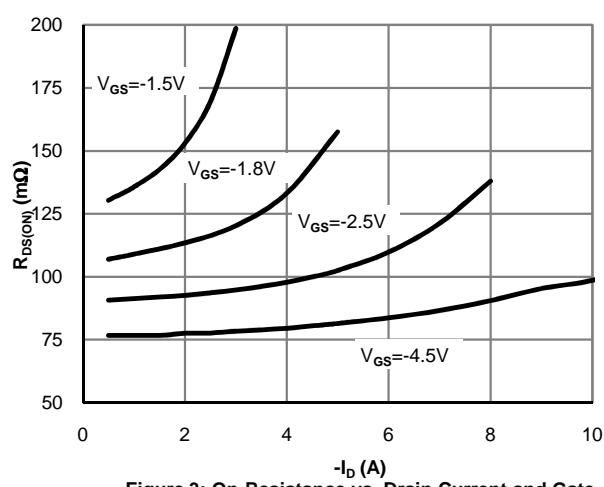
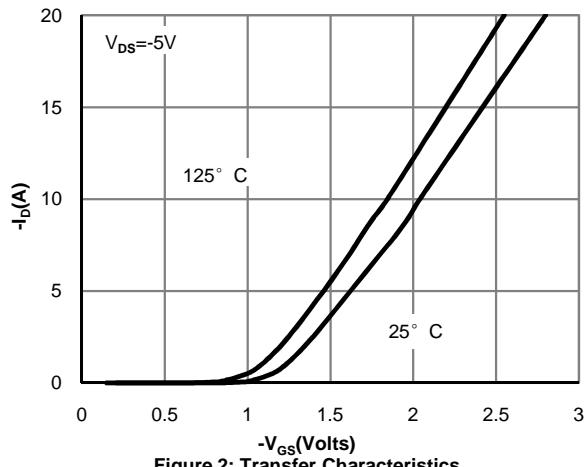
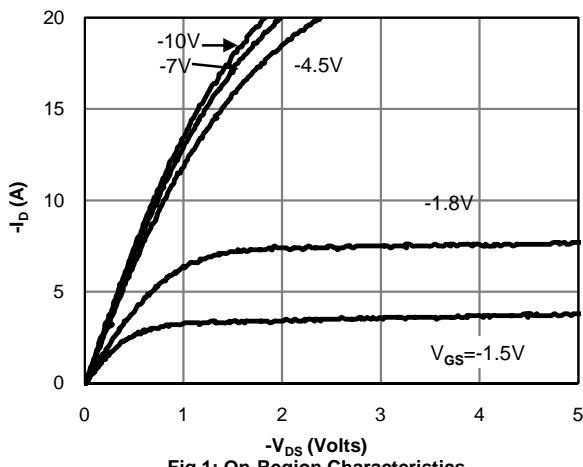
Note 1. Mounted on minimum pad PCB

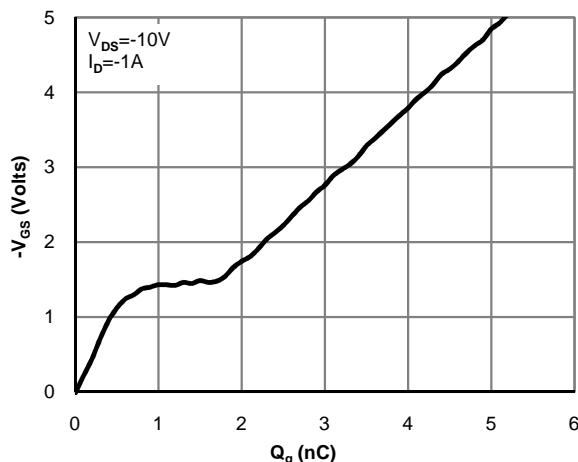
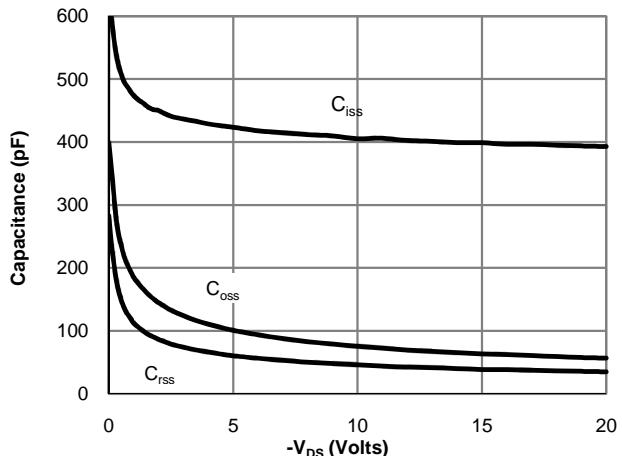
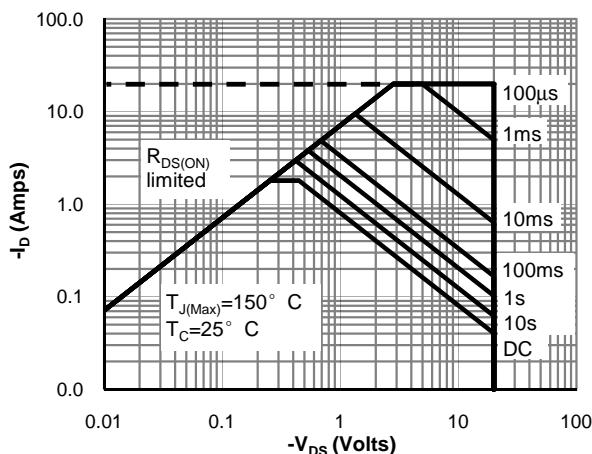
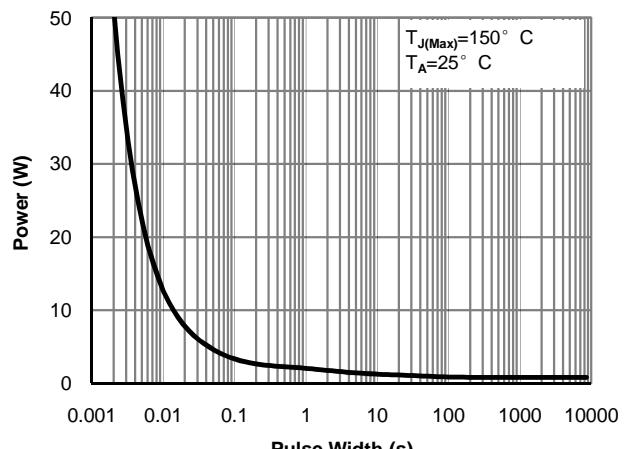
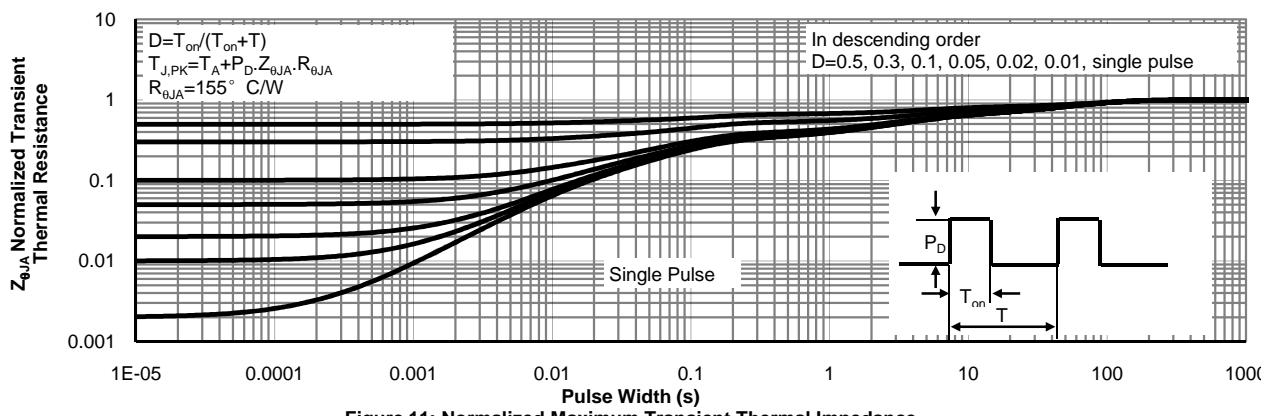
Note 2. PW <300 μs pulses, duty cycle 0.5% max

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Source-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-20			V
I_{DSS}	Zero Gate Voltage Source Current	$V_{DS}=-20\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			-1 -5	μA
I_{GSS}	Gate leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 8\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.3	-0.65	-1	V
$R_{\text{DS(ON)}}$	Static Source to Source On-Resistance	$V_{GS}=-4.5\text{V}, I_D=-1\text{A}$		76	95	$\text{m}\Omega$
		$T_J=125^\circ\text{C}$		105	132	
		$V_{GS}=-2.5\text{V}, I_D=-1\text{A}$		91	115	
		$V_{GS}=-1.8\text{V}, I_D=-0.5\text{A}$		107	150	
		$V_{GS}=-1.5\text{V}, I_D=-0.5\text{A}$		130	200	
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-1\text{A}$		7		S
V_{FSD}	Diode Forward Voltage	$I_D=-1\text{A}, V_{GS}=0\text{V}$		-0.73	-1	V
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-10\text{V}, f=1\text{MHz}$		405		pF
C_{oss}	Output Capacitance			75		pF
C_{rss}	Reverse Transfer Capacitance			45		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		26		Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, I_D=-1\text{A}$		4.8		nC
Q_{gs}	Gate Source Charge			0.8		nC
Q_{gd}	Gate Drain Charge			1		nC
$t_{\text{D(on)}}$	Turn-On DelayTime	$V_{GS}=-4.5\text{V}, V_{DS}=-10\text{V}, R_L=10\Omega, I_D=-1\text{A}, R_{\text{GEN}}=6\Omega$		7.5		ns
t_r	Turn-On Rise Time			8.5		
$t_{\text{D(off)}}$	Turn-Off DelayTime			95		
t_f	Turn-Off Fall Time			30		
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-1\text{A}, dI/dt=100\text{A}/\mu\text{s}$		22		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-1\text{A}, dI/dt=100\text{A}/\mu\text{s}$		8.5		nC

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


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Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area

Figure 10: Single Pulse Power Rating Junction-to-Ambient

Figure 11: Normalized Maximum Transient Thermal Impedance